

## N-channel 600 V, 168 mΩ typ., 18 A MDmesh M2 Power MOSFET in TO-3PF package

### Features

| Order code  | $V_{DS} @ T_{Jmax}$ | $R_{DS(on)} \text{ max.}$ | $I_D$ |
|-------------|---------------------|---------------------------|-------|
| STFW24N60M2 | 650 V               | 190 mΩ                    | 18 A  |

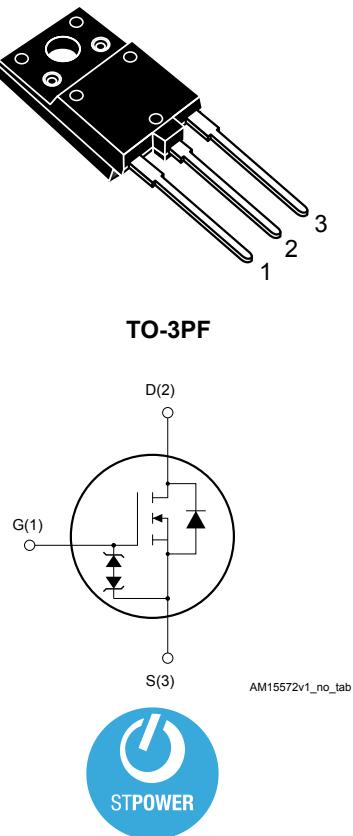
- Extremely low gate charge
- Excellent output capacitance ( $C_{oss}$ ) profile
- 100% avalanche tested
- Zener-protected

### Applications

- Switching applications
- LCC converters
- Resonant converters

### Description

This device is an N-channel Power MOSFET developed using MDmesh M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.



#### Product status link

[STFW24N60M2](#)

#### Product summary

|            |             |
|------------|-------------|
| Order code | STFW24N60M2 |
| Marking    | 24N60M2     |
| Package    | TO-3PF      |
| Packing    | Tube        |

## 1 Electrical ratings

**Table 1. Absolute maximum ratings**

| Symbol                  | Parameter  | Value      | Unit             |
|-------------------------|--|------------|------------------|
| $V_{GS}$                | Gate-source voltage  | $\pm 25$   | V                |
| $I_D$ <sup>(1)</sup>    | Drain current (continuous) at $T_C = 25^\circ\text{C}$   | 18         | A                |
|                         | Drain current (continuous) at $T_C = 100^\circ\text{C}$  | 12         | A                |
| $I_{DM}$ <sup>(2)</sup> | Drain current (pulsed)   | 72         | A                |
| $P_{TOT}$               | Total power dissipation at $T_C = 25^\circ\text{C}$  | 48         | W                |
| $dv/dt$ <sup>(3)</sup>  | Peak diode recovery voltage slope  | 15         | V/ns             |
| $dv/dt$ <sup>(4)</sup>  | MOSFET dv/dt ruggedness  | 50         | V/ns             |
| $V_{ISO}$               | Insulation withstand voltage (RMS) from all three leads to external heat sink ( $t = 1 \text{ s}$ ; $T_C = 25^\circ\text{C}$ ) | 3.5        | kV               |
| $T_{stg}$               | Storage temperature range  | -55 to 150 | $^\circ\text{C}$ |
| $T_j$                   | Operating junction temperature range   |            |                  |

1. Limited by maximum junction temperature.
2. Pulse width limited by safe operating area.
3.  $I_{SD} \leq 18 \text{ A}$ ,  $di/dt \leq 400 \text{ A}/\mu\text{s}$ ;  $V_{DS(peak)} < V_{(BR)DSS}$ ,  $V_{DD} = 400 \text{ V}$
4.  $V_{DS} \leq 480 \text{ V}$

**Table 2. Thermal data**

| Symbol         | Parameter                           | Value | Unit               |
|----------------|-------------------------------------|-------|--------------------|
| $R_{thj-case}$ | Thermal resistance junction-case    | 2.6   | $^\circ\text{C/W}$ |
| $R_{thj-amb}$  | Thermal resistance junction-ambient | 50    | $^\circ\text{C/W}$ |

**Table 3. Avalanche characteristics**

| Symbol   | Parameter   | Value | Unit |
|----------|---|-------|------|
| $I_{AR}$ | Avalanche current, repetitive or not repetitive (pulse width limited by $T_{jmax}$ )                    | 3.5   | A    |
| $E_{AS}$ | Single pulse avalanche energy (starting $T_j=25^\circ\text{C}$ , $I_D=I_{AR}$ , $V_{DD}=50 \text{ V}$ ) | 180   | mJ   |

## 2 Electrical characteristics

( $T_C = 25^\circ\text{C}$  unless otherwise specified).

**Table 4. On /off states**

| Symbol                      | Parameter                         | Test conditions   | Min. | Typ. | Max.     | Unit             |
|-----------------------------|-----------------------------------|---|------|------|----------|------------------|
| $V_{(\text{BR})\text{DSS}}$ | Drain-source breakdown voltage    | $I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}$                                  | 600  |      |          | V                |
| $I_{\text{DSS}}$            | Zero gate voltage drain current   | $V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V}$                              |      |      | 1        | $\mu\text{A}$    |
|                             |                                   | $V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V}, T_C = 125^\circ\text{C}$ (1) |      |      | 100      | $\mu\text{A}$    |
| $I_{\text{GSS}}$            | Gate-body leakage current         | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$                           |      |      | $\pm 10$ | $\mu\text{A}$    |
| $V_{GS(\text{th})}$         | Gate threshold voltage            | $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$                                    | 2    | 3    | 4        | V                |
| $R_{\text{DS(on)}}$         | Static drain-source on-resistance | $V_{GS} = 10 \text{ V}, I_D = 9 \text{ A}$                                  |      | 168  | 190      | $\text{m}\Omega$ |

1. Defined by design, not subject to production test.

**Table 5. Dynamic**

| Symbol                      | Parameter                     | Test conditions  | Min. | Typ. | Max. | Unit     |
|-----------------------------|-------------------------------|--|------|------|------|----------|
| $C_{iss}$                   | Input capacitance             | $V_{DS} = 100 \text{ V}, f = 1 \text{ MHz}, V_{GS} = 0 \text{ V}$  | -    | 1060 | -    | pF       |
| $C_{oss}$                   | Output capacitance            |  | -    | 55   | -    | pF       |
| $C_{rss}$                   | Reverse transfer capacitance  |  | -    | 2.2  | -    | pF       |
| $C_{oss \text{ eq.}}^{(1)}$ | Equivalent output capacitance | $V_{DS} = 0 \text{ to } 480 \text{ V}, V_{GS} = 0 \text{ V}$   | -    | 258  | -    | pF       |
| $R_G$                       | Intrinsic gate resistance     | $f = 1 \text{ MHz}, I_D = 0 \text{ A}$   | -    | 7    | -    | $\Omega$ |
| $Q_g$                       | Total gate charge             | $V_{DD} = 480 \text{ V}, I_D = 18 \text{ A}, V_{GS} = 0 \text{ to } 10 \text{ V}$ (see Figure 14. Test circuit for gate charge behavior) | -    | 29   | -    | nC       |
| $Q_{gs}$                    | Gate-source charge            |  | -    | 6    | -    | nC       |
| $Q_{gd}$                    | Gate-drain charge             |  | -    | 12   | -    | nC       |

1.  $C_{oss \text{ eq.}}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ .

**Table 6. Switching times**

| Symbol       | Parameter           | Test conditions   | Min. | Typ. | Max. | Unit |
|--------------|---------------------|---|------|------|------|------|
| $t_{d(on)}$  | Turn-on delay time  | $V_{DD} = 300 \text{ V}, I_D = 9 \text{ A}, R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$                    | -    | 14   | -    | ns   |
| $t_r$        | Rise time           |   | -    | 9    | -    | ns   |
| $t_{d(off)}$ | Turn-off delay time | (see Figure 13. Test circuit for resistive load switching times and Figure 18. Switching time waveform) | -    | 60   | -    | ns   |
| $t_f$        | Fall time           |   | -    | 15   | -    | ns   |

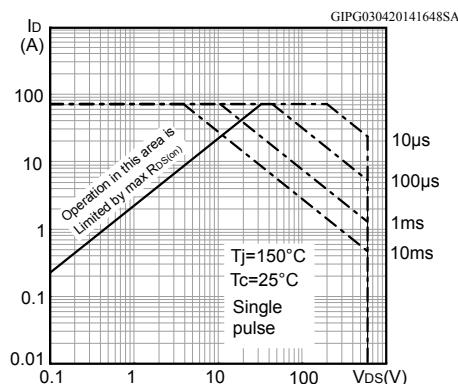
**Table 7. Source-drain diode**

| Symbol                   | Parameter                     | Test conditions   | Min. | Typ. | Max. | Unit          |
|--------------------------|-------------------------------|---|------|------|------|---------------|
| $I_{SD}$ <sup>(1)</sup>  | Source-drain current          |   | -    |      | 18   | A             |
| $I_{SDM}$ <sup>(2)</sup> | Source-drain current (pulsed) |   | -    |      | 72   | A             |
| $V_{SD}$ <sup>(3)</sup>  | Forward on voltage            | $I_{SD} = 18 \text{ A}, V_{GS} = 0 \text{ V}$   | -    |      | 1.6  | V             |
| $t_{rr}$                 | Reverse recovery time         | $I_{SD} = 18 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}$  | -    | 332  |      | ns            |
| $Q_{rr}$                 | Reverse recovery charge       | $V_{DD} = 60 \text{ V}$ (see Figure 15. Test circuit for inductive load switching and diode recovery times)                                   | -    | 4    |      | $\mu\text{C}$ |
| $I_{RRM}$                | Reverse recovery current      |   | -    | 24   |      | A             |
| $t_{rr}$                 | Reverse recovery time         | $I_{SD} = 18 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}$  | -    | 450  |      | ns            |
| $Q_{rr}$                 | Reverse recovery charge       | $V_{DD} = 60 \text{ V}, T_j = 150 \text{ }^\circ\text{C}$ (see Figure 15. Test circuit for inductive load switching and diode recovery times) | -    | 5.5  |      | $\mu\text{C}$ |
| $I_{RRM}$                | Reverse recovery current      |   | -    | 25   |      | A             |

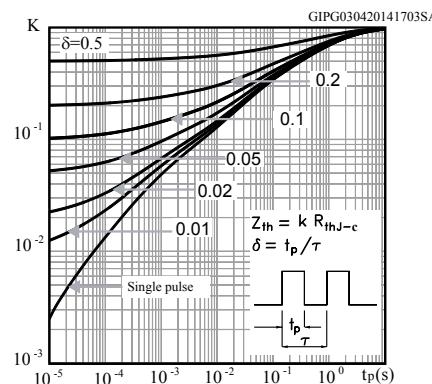
1. Limited by maximum junction temperature.
2. Pulse width limited by safe operating area.
3. Pulsed: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%.

## 2.1 Electrical characteristics (curves)

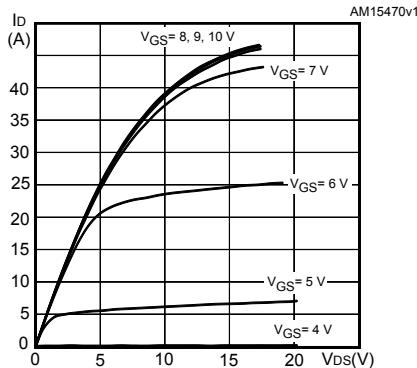
**Figure 1. Safe operating area**



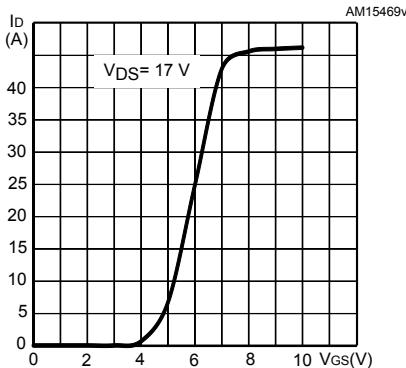
**Figure 2. Thermal impedance**



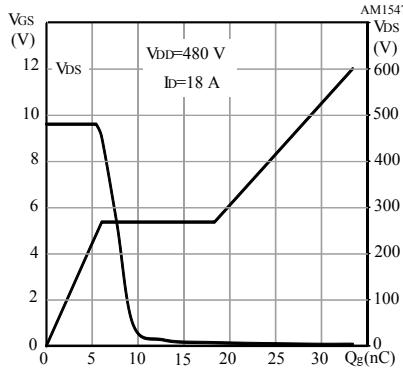
**Figure 3. Output characteristics**



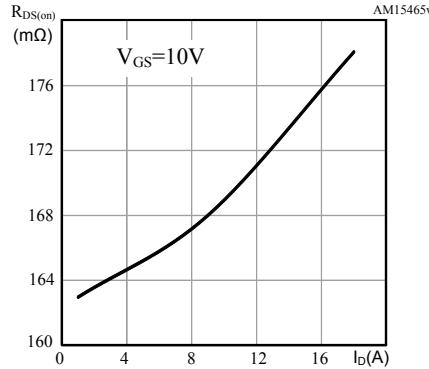
**Figure 4. Transfer characteristics**

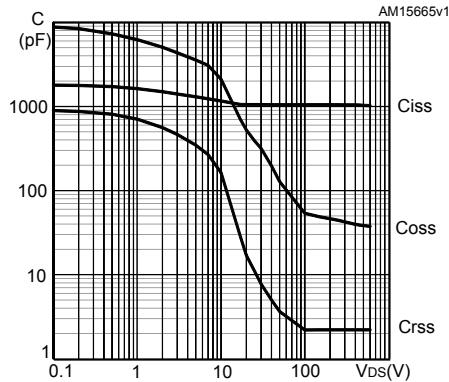
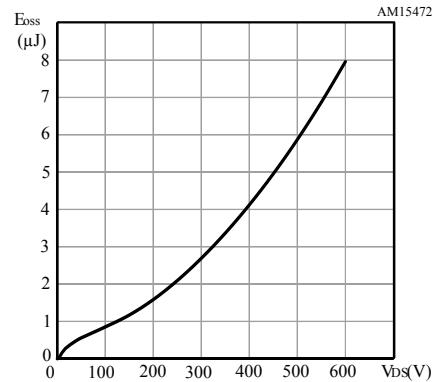
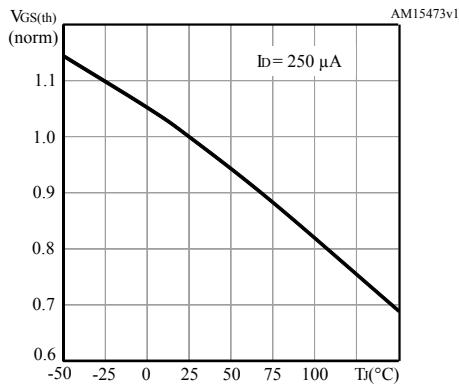
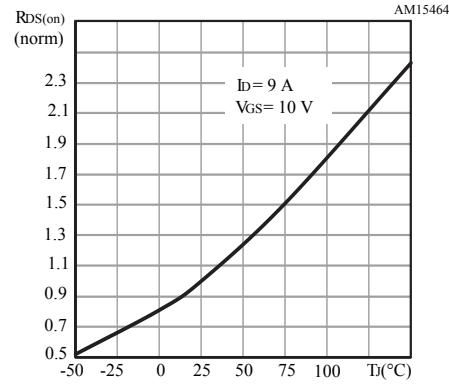
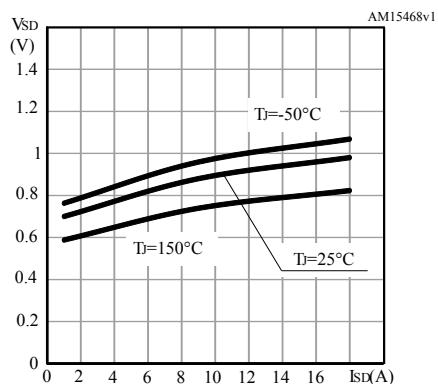
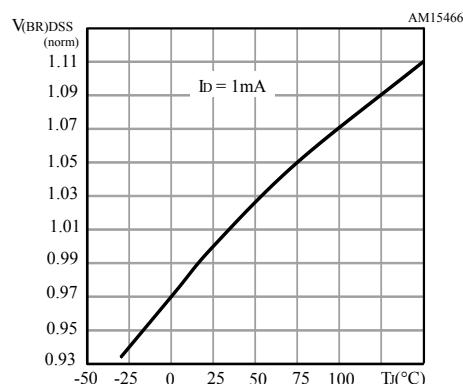


**Figure 5. Gate charge vs gate-source voltage**



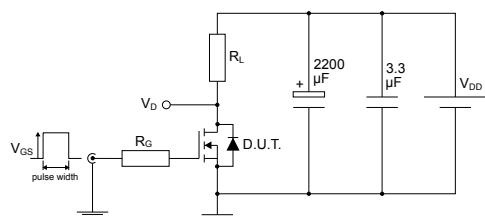
**Figure 6. Static drain-source on-resistance**



**Figure 7. Capacitance variations**

**Figure 8. Output capacitance stored energy**

**Figure 9. Normalized gate threshold voltage vs temperature**

**Figure 10. Normalized on-resistance vs temperature**

**Figure 11. Source-drain diode forward characteristics**

**Figure 12. Normalized V<sub>(BR)DSS</sub> vs temperature**


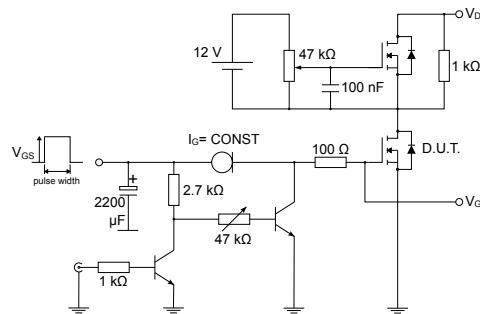
### 3 Test circuits

**Figure 13.** Test circuit for resistive load switching times



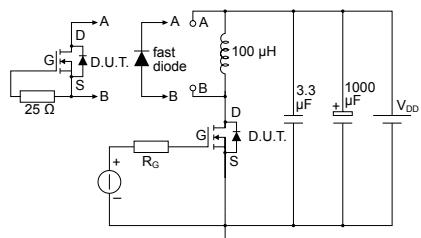
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**Figure 14.** Test circuit for gate charge behavior



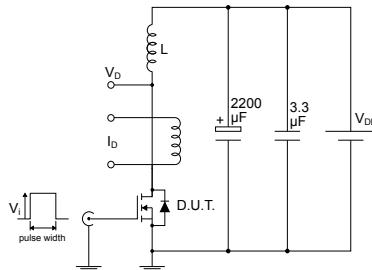
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**Figure 15.** Test circuit for inductive load switching and diode recovery times



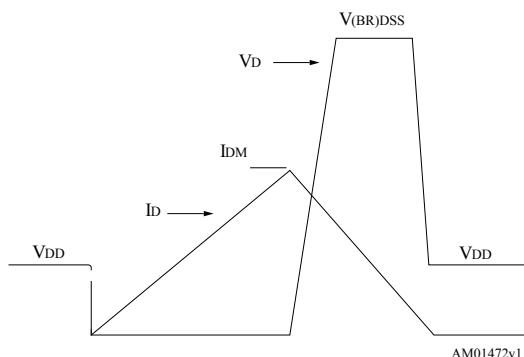
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**Figure 16.** Unclamped inductive load test circuit



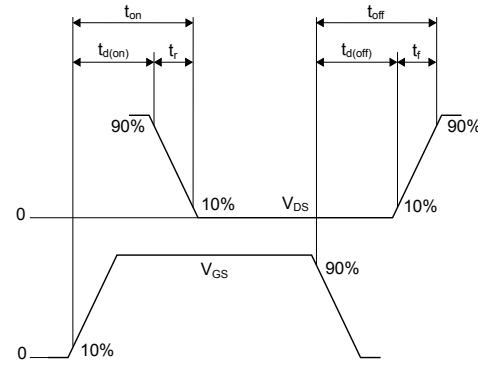
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**Figure 17.** Unclamped inductive waveform



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**Figure 18.** Switching time waveform



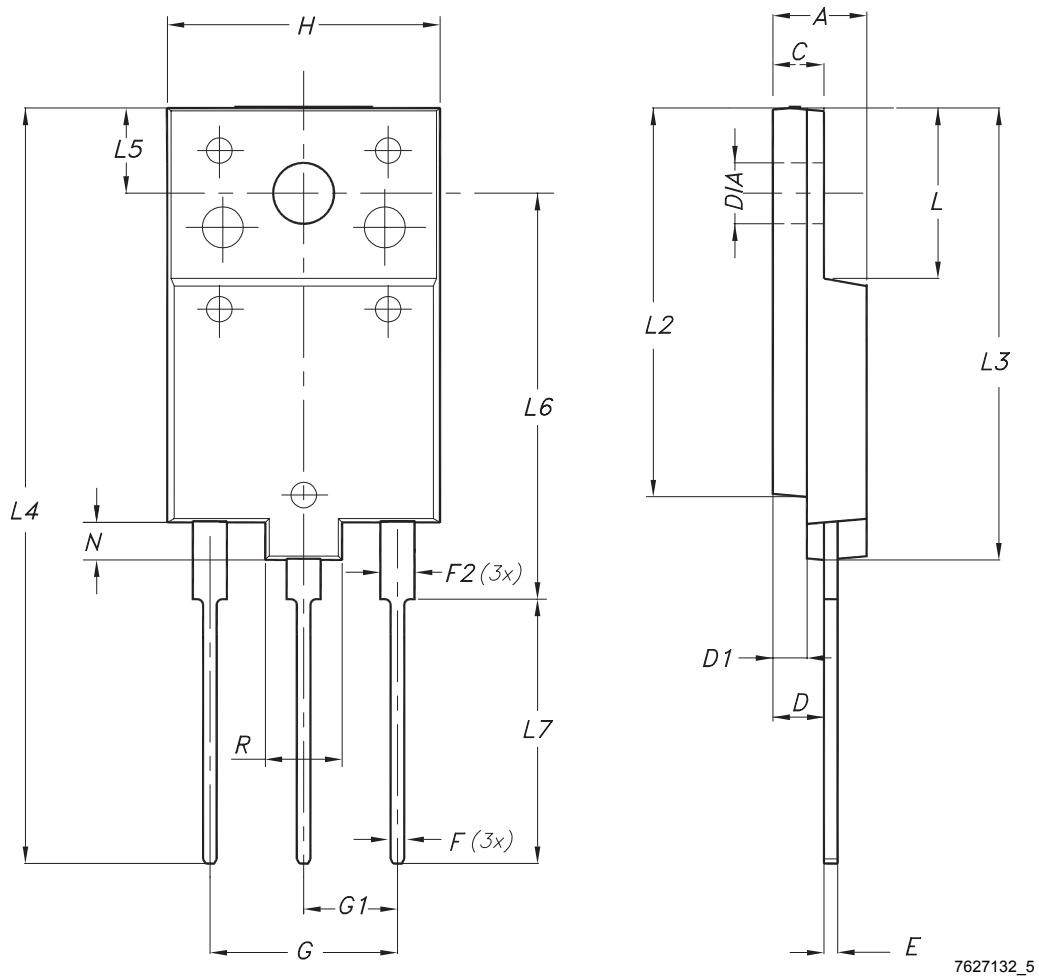
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## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

### 4.1 TO-3PF package information

Figure 19. TO-3PF package outline



**Table 8. TO-3PF mechanical data**

| Dim. | mm    |      |       |
|------|-------|------|-------|
|      | Min.  | Typ. | Max.  |
| A    | 5.30  |      | 5.70  |
| C    | 2.80  |      | 3.20  |
| D    | 3.10  |      | 3.50  |
| D1   | 1.80  |      | 2.20  |
| E    | 0.80  |      | 1.10  |
| F    | 0.65  |      | 0.95  |
| F2   | 1.80  |      | 2.20  |
| G    | 10.30 |      | 11.50 |
| G1   |       | 5.45 |       |
| H    | 15.30 |      | 15.70 |
| L    | 9.80  | 10   | 10.20 |
| L2   | 22.80 |      | 23.20 |
| L3   | 26.30 |      | 26.70 |
| L4   | 43.20 |      | 44.40 |
| L5   | 4.30  |      | 4.70  |
| L6   | 24.30 |      | 24.70 |
| L7   | 14.60 |      | 15    |
| N    | 1.80  |      | 2.20  |
| R    | 3.80  |      | 4.20  |
| Dia  | 3.40  |      | 3.80  |

## Revision history

**Table 9. Document revision history**

| Date        | Revision | Changes  |
|-------------|----------|--|
| 20-Feb-2020 | 1        | First release. Part number previously included in datasheet DocID024026. |

## Contents

|            |   |           |
|------------|---|-----------|
| <b>1</b>   | <b>Electrical ratings .....</b>           | <b>2</b>  |
| <b>2</b>   | <b>Electrical characteristics.....</b>    | <b>3</b>  |
| <b>2.1</b> | Electrical characteristics (curves) ..... | 5         |
| <b>3</b>   | <b>Test circuits .....</b>                | <b>7</b>  |
| <b>4</b>   | <b>Package information.....</b>           | <b>8</b>  |
| <b>4.1</b> | TO-3PF package information.....           | 8         |
|            | <b>Revision history .....</b>             | <b>10</b> |

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